



Vincotech

B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z

datasheet

flowNPC S3 split

950 V / 600 A

Features

- High power low inductive package
- Improved R_{th} with AlN DCB
- Integrated NTC

flow S3 12 mm housing



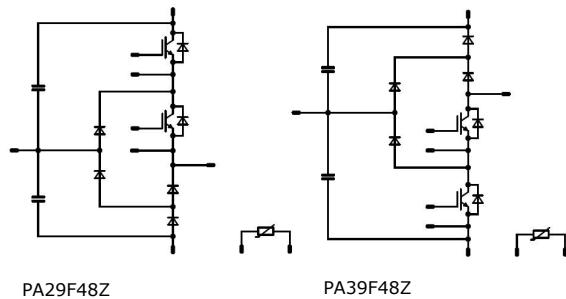
Target applications

- Solar Inverters

Types

- B0-SL10NIB600S701-PA29F48Z
- B0-SL10NIC600S701-PA39F48Z

Schematic





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**B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z**

datasheet

Maximum Ratings

 $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Buck Switch				
Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	444	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	1200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	864	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	171	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	728	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 25 \text{ }^\circ\text{C}$	1040	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	432	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	77	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	160	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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 $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	602	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	1200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	750	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	209	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	413	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Sw. Inv. Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	209	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	413	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

 $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Sw. Protection Diode				
Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	77	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	160	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost D. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	77	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	160	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Capacitor (DC)

Maximum DC voltage	V_{MAX}		1000	V
Operation Temperature	T_{op}		-55 ... 125	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1 \text{ min}$	2500	V
Creepage distance		B0-SL10NIB600S701-PA29F48Z B0-SL10NIC600S701-PA39F48Z	10.55 9.93	mm
Clearance		B0-SL10NIB600S701-PA29F48Z B0-SL10NIC600S701-PA39F48Z	10.55 8.06	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE} = V_{GE}$			0,00975	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		600	25 125 150		1,82 2,07 2,13	2,25 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			12	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							0,5		Ω
Input capacitance	C_{res}	$f = 100 \text{ kHz}$	0	25	25	25	37800		pF	
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15		0	25		1350		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{\text{th(j-s)}}$	$\lambda_{\text{paste}} = 4,4 \text{ W/mK}$ (PTM)						0,11		K/W
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Dynamic

Turn-on delay time	$t_{d(\text{on})}$	$R_{\text{gon}} = 2 \Omega$ $R_{\text{goff}} = 2 \Omega$	± 15	600	355	25		211,84		
Rise time	t_r					125		214,72		ns
						150		216,32		
Turn-off delay time	$t_{d(\text{off})}$					25		33,6		
						125		36,16		
Fall time	t_f					150		36,8		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD}=2,03 \mu\text{C}$ $Q_{fFWD}=4,81 \mu\text{C}$ $Q_{ffwd}=5,98 \mu\text{C}$				25		177,28		
						125		211,52		
Turn-off energy (per pulse)	E_{off}					150		220,48		
						25		23,48		
						125		42,87		
						150		49,36		ns
						25		13,03		
						125		13,86		mWs
						150		14,12		
						25		9,81		
						125		15,27		mWs
						150		17,09		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Buck Diode

Static

Forward voltage	V_F				160	25 125 150		1,72 2,17 2,32	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 1200$ V			25		280	1600	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,22		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=7077$ A/ μ s $di/dt=7276$ A/ μ s $di/dt=7141$ A/ μ s	± 15	600	355	25		70,95		
Reverse recovery time	t_{rr}					125		132,07		
Recovered charge	Q_r					150		130,46		A
Recovered charge	Q_r	$di/dt=7077$ A/ μ s $di/dt=7276$ A/ μ s $di/dt=7141$ A/ μ s	± 15	600	355	25		48,1		ns
Reverse recovered energy	E_{rec}					125		83,38		
Reverse recovered energy	E_{rec}					150		82,72		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	$di/dt=7077$ A/ μ s $di/dt=7276$ A/ μ s $di/dt=7141$ A/ μ s	± 15	600	355	25		2,03		μ C
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		4,81		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		5,98		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	$di/dt=7077$ A/ μ s $di/dt=7276$ A/ μ s $di/dt=7141$ A/ μ s	± 15	600	355	25		0,588		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		1,77		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		2,31		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	$di/dt=7077$ A/ μ s $di/dt=7276$ A/ μ s $di/dt=7141$ A/ μ s	± 15	600	355	25		9934		A/ μ s
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		8057		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		1496		



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B0-SL10NIC600S701-PA39F48Z**

datasheet

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Buck Sw. Protection Diode

Static

Forward voltage	V_F				100	25 125 150	2,1	2,64 2,44 2,36	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25				4	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,59		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00975	25	4,15	4,85	5,65	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		600	25 125 150		1,21 1,23 1,24	1,4 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			12	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							0,5		Ω
Input capacitance	C_{res}	$f = 100$ kHz	0	25	25	25	73800	795	330	pF
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15		0	25		6150		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,13		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	± 15	600	600	25		488,96		
Rise time	t_r					125		493,44		
						150		498,24		ns
Turn-off delay time	$t_{d(off)}$					25		50,24		
						125		54,4		
Fall time	t_f					150		56		ns
Turn-on energy (per pulse)	E_{on}					25		395,52		
		$Q_{fFWD}=10,1 \mu C$				125		447,68		
		$Q_{fFWD}=24 \mu C$				150		460,8		
Turn-off energy (per pulse)	E_{off}	$Q_{fFWD}=29,02 \mu C$				25		250,52		
						125		341,62		
						150		358,11		ns
						25		23,23		
						125		27,36		mWs
						150		29,06		
						25		78,24		
						125		106,17		mWs
						150		113,82		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Diode

Static

Forward voltage	V_F				300	25 125 150	2,1	2,59 2,43 2,37	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25			12	μA	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,23		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=10313$ A/μs $di/dt=9888$ A/μs $di/dt=9489$ A/μs	± 15	600	600	25		195,57		A
Reverse recovery time	t_{rr}					125		279,82		
Recovered charge	Q_r					150		299,08		
Reverse recovered energy	E_{rec}		± 15	600	600	25		145,91		ns
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		218,84		
						150		244,17		
			± 15	600	600	25		10,1		μC
						125		24		
						150		29,02		
			± 15	600	600	25		2,99		mWs
						125		8,09		
						150		9,95		
			± 15	600	600	25		8181		A/μs
						125		4351		
						150		4085		



BO-SL10NIB600S701-PA29F48Z
BO-SL10NIC600S701-PA39F48Z

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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Sw. Inv. Diode

Static

Forward voltage	V_F				300	25 125 150	2,1	2,59 2,43 2,37	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25				12	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,23		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Boost Sw. Protection Diode

Static

Forward voltage	V_F				100	25 125 150	2,1	2,64 2,44 2,36	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25				4	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,59		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Boost D. Protection Diode

Static

Forward voltage	V_F				100	25 125 150	2,1	2,64 2,44 2,36	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V			25				4	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,59		K/W
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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		10		nF
Tolerance							-5		5	%
Dissipation factor		$f = 1$ kHz				25		0,1		%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference								I		

⁽¹⁾ Value at chip level⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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B0-SL10NIC600S701-PA39F48Z

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Buck Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

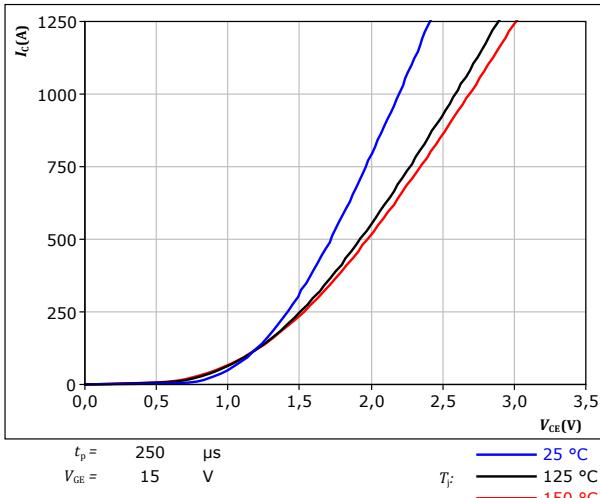


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

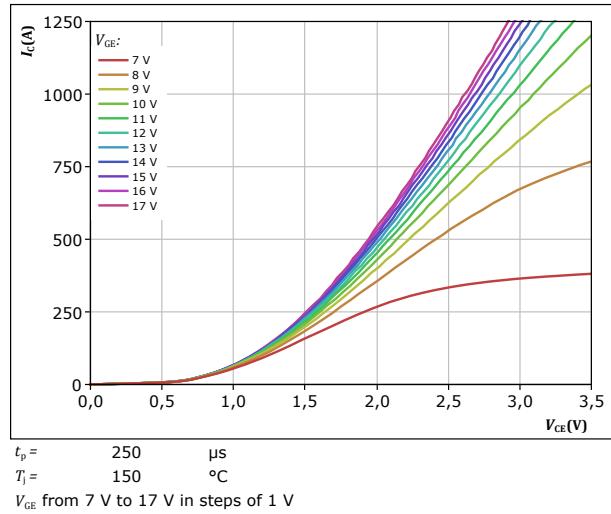


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

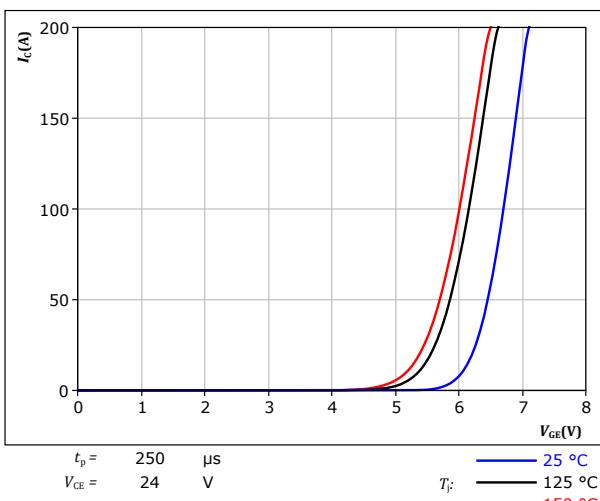
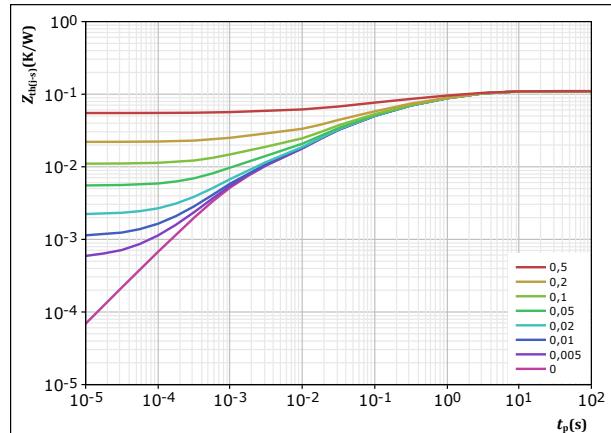


figure 4. IGBT

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



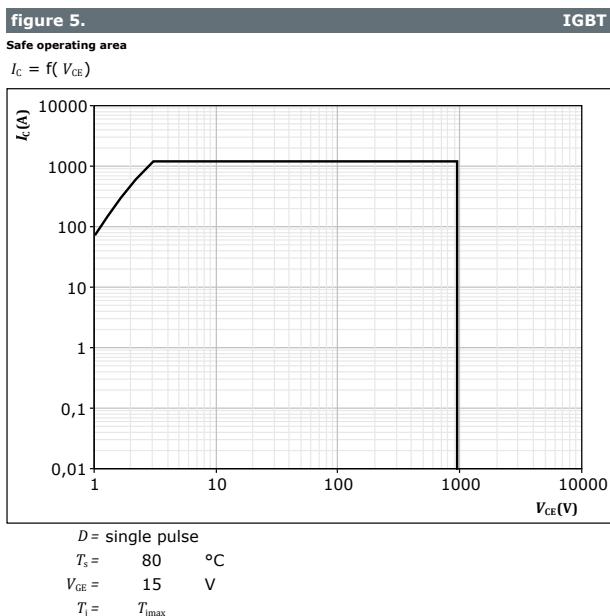


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Buck Switch Characteristics



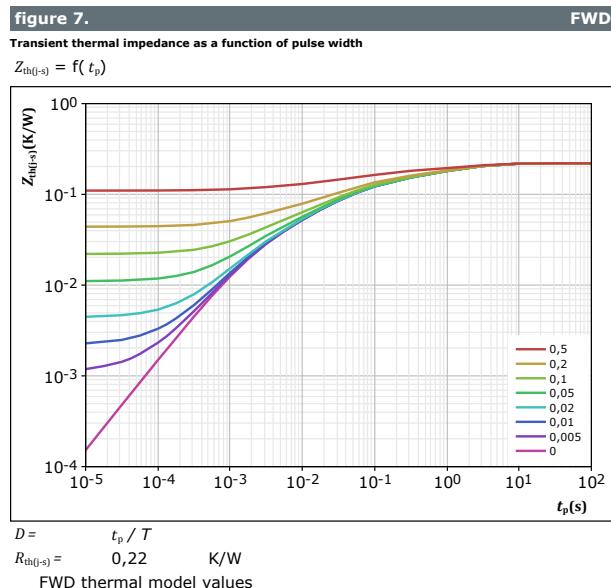
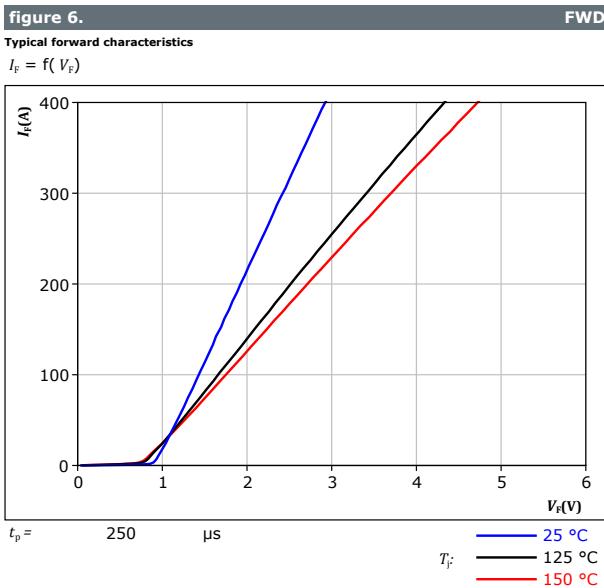


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Buck Diode Characteristics





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Buck Sw. Protection Diode Characteristics

figure 8.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

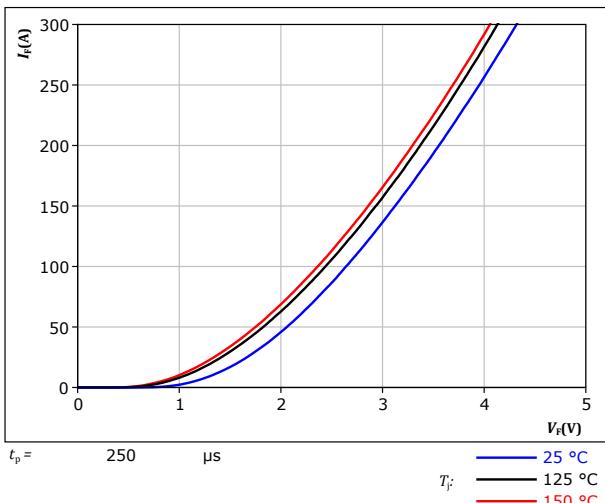
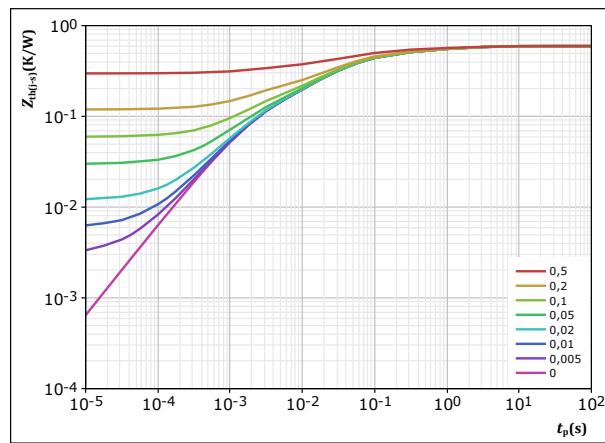


figure 9.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,594 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



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Boost Switch Characteristics

figure 10. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

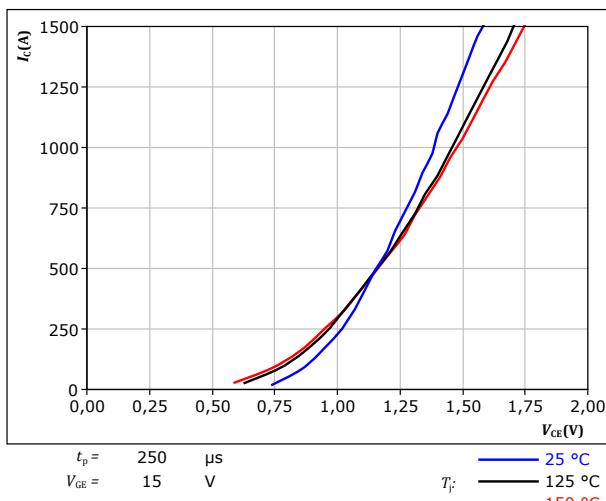


figure 11. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

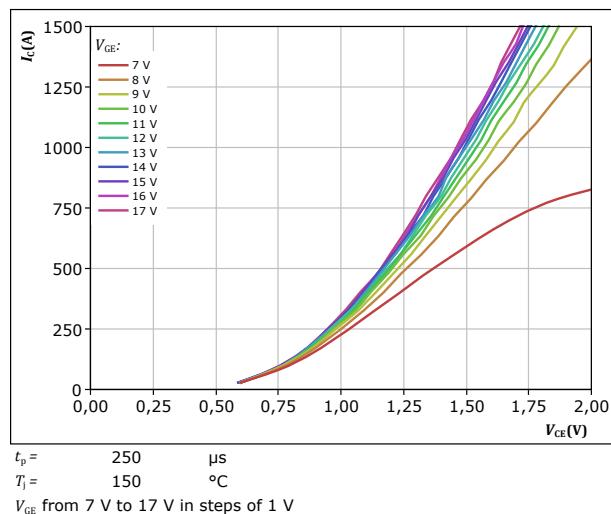


figure 12. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

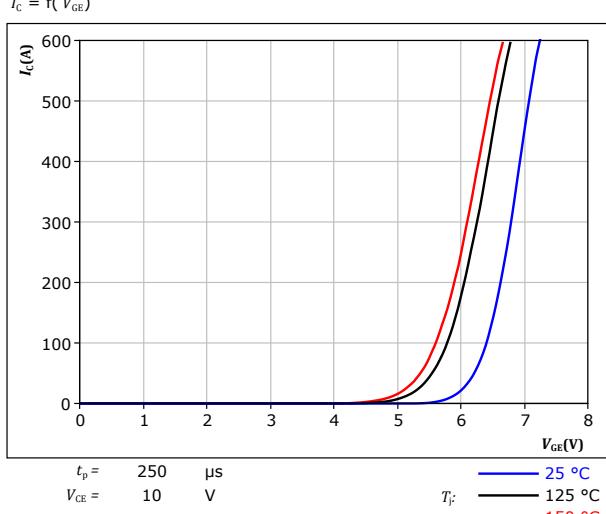
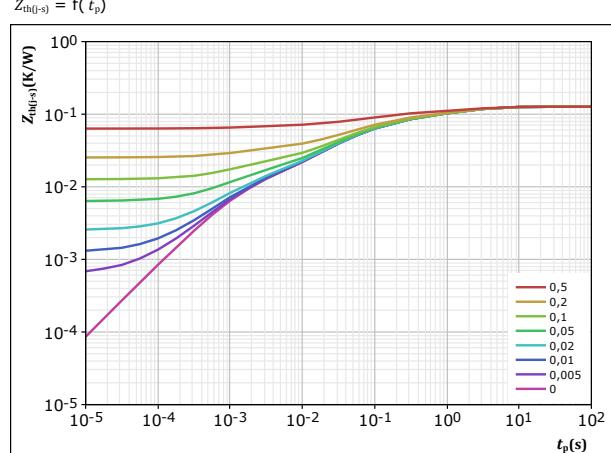


figure 13. IGBT

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



IGBT thermal model values

R (K/W)	τ (s)
2,24E-02	3,16E+00
3,10E-02	7,01E-01
4,64E-02	8,63E-02
1,79E-02	1,89E-02
9,01E-03	1,26E-03

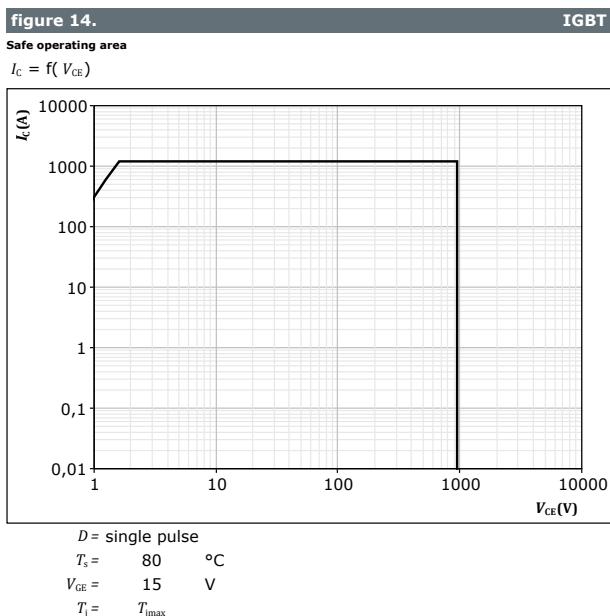


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datasheet

Boost Switch Characteristics





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datasheet

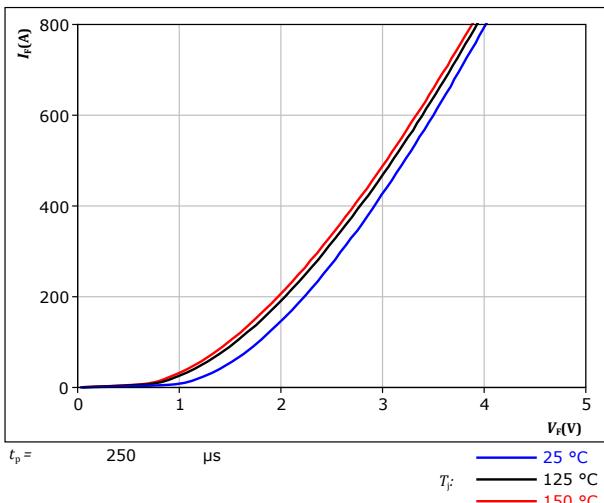
Boost Diode Characteristics

figure 15.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

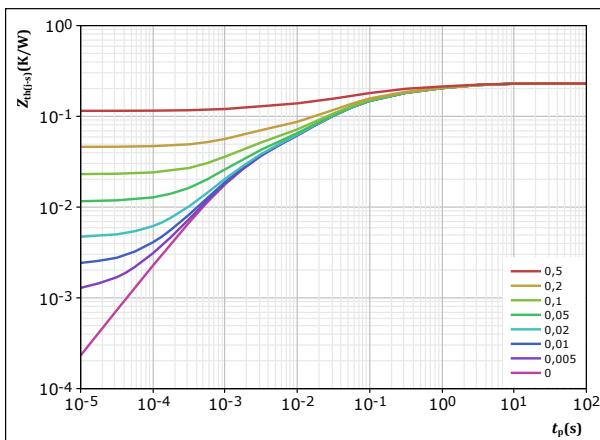
$T_F:$
 — 25 °C
 — 125 °C
 — 150 °C

figure 16.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,23 \quad \text{K/W}$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
2,56E-02	2,90E+00
4,35E-02	5,53E-01
9,09E-02	6,81E-02
4,34E-02	1,43E-02
2,66E-02	1,41E-03



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datasheet

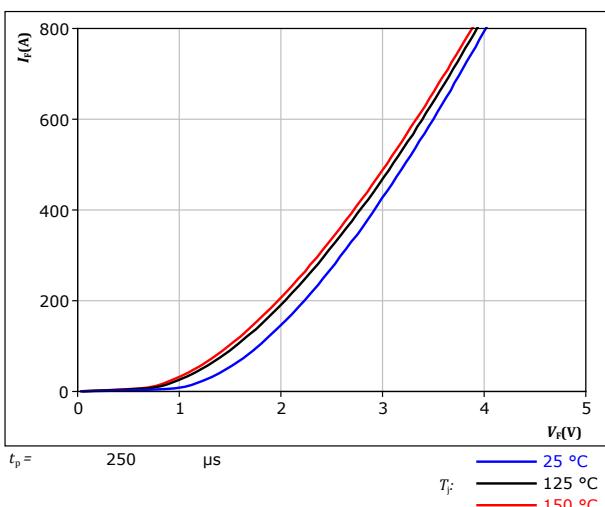
Boost Sw. Inv. Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

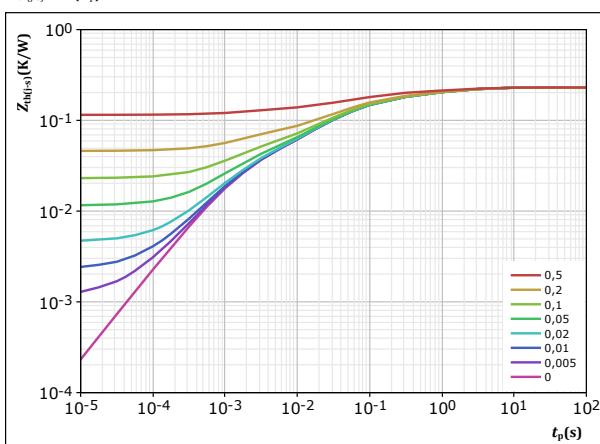
$$T_F: \begin{cases} 25^\circ\text{C} \\ 125^\circ\text{C} \\ 150^\circ\text{C} \end{cases}$$

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,23 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
2,56E-02	2,90E+00
4,35E-02	5,53E-01
9,09E-02	6,81E-02
4,34E-02	1,43E-02
2,66E-02	1,41E-03



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datasheet

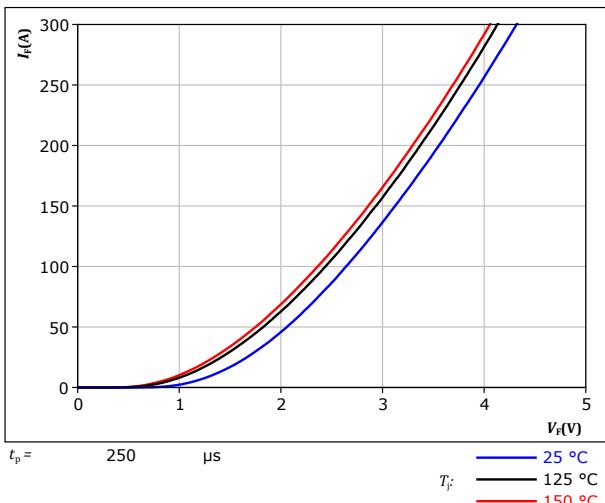
Boost Sw. Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

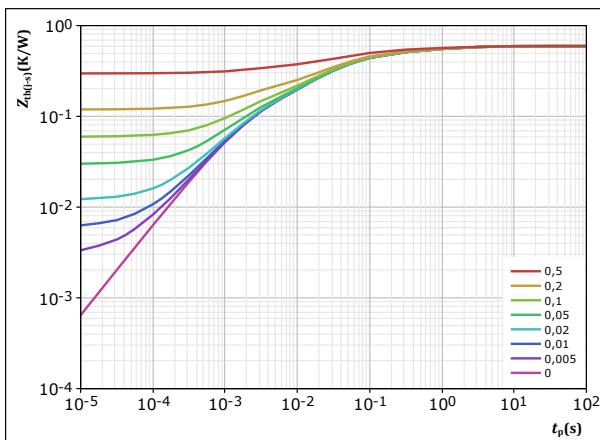
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 20.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,594 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



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datasheet

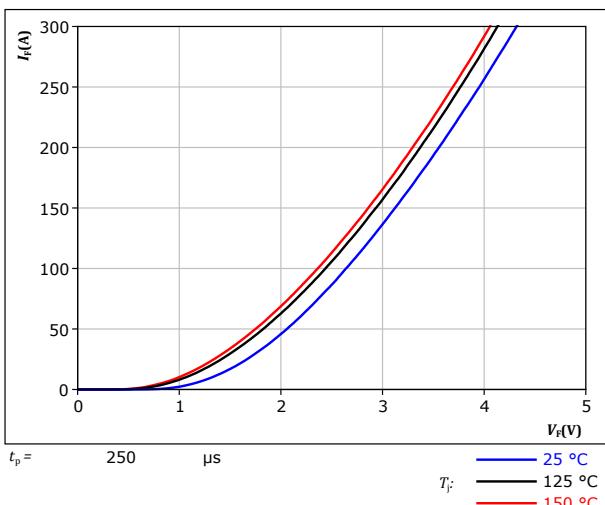
Boost D. Protection Diode Characteristics

figure 21.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

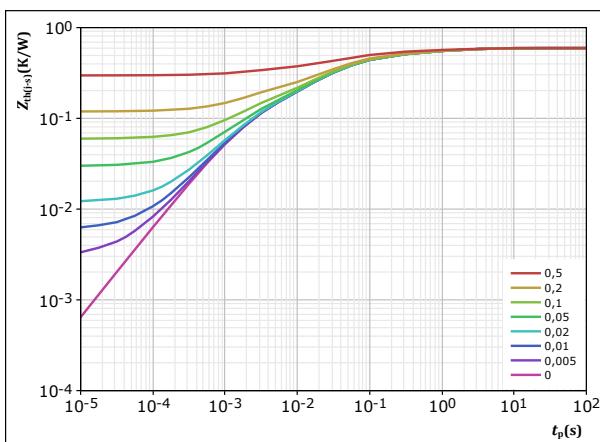
$T_F:$
 — 25 °C
 — 125 °C
 — 150 °C

figure 22.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{0,594} \quad K/W$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03

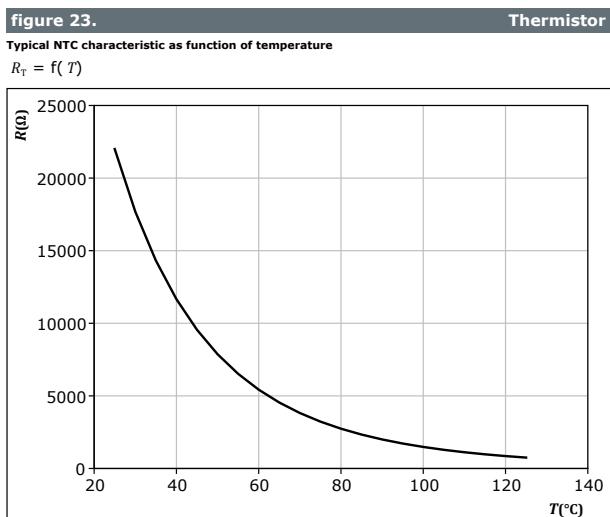


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datasheet

Thermistor Characteristics





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B0-SL10NIC600S701-PA39F48Z

datasheet

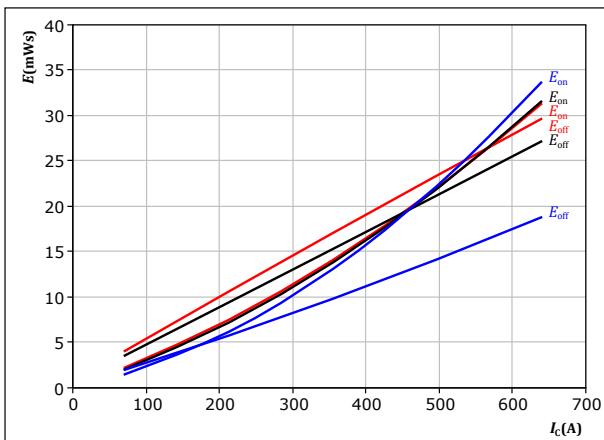
Buck Switching Characteristics

figure 24.

Typical switching energy losses as a function of collector current

IGBT

$$E = f(I_c)$$



With an inductive load at

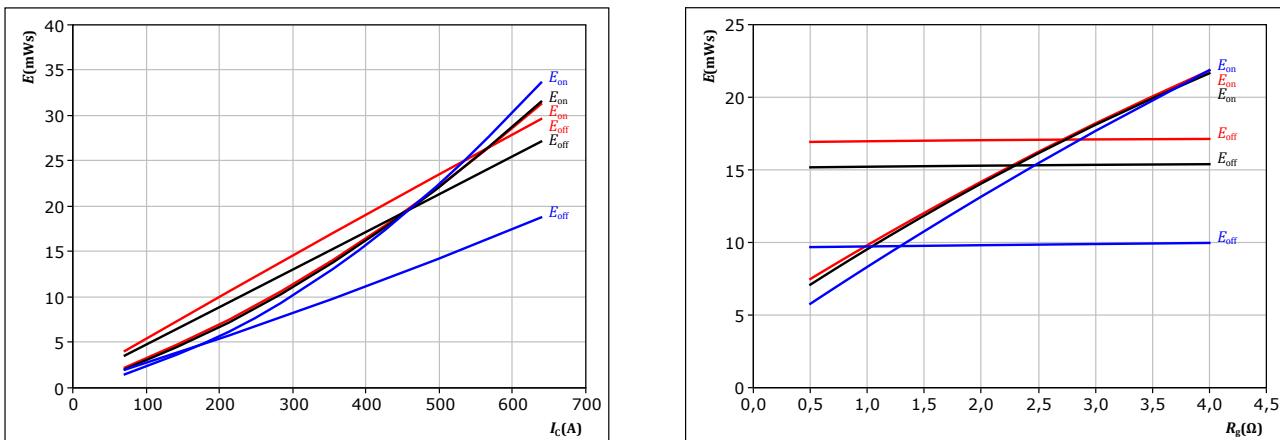
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \\ R_{goff} &= 2 \Omega & & \end{aligned}$$

figure 25.

Typical switching energy losses as a function of gate resistor

IGBT

$$E = f(R_g)$$



With an inductive load at

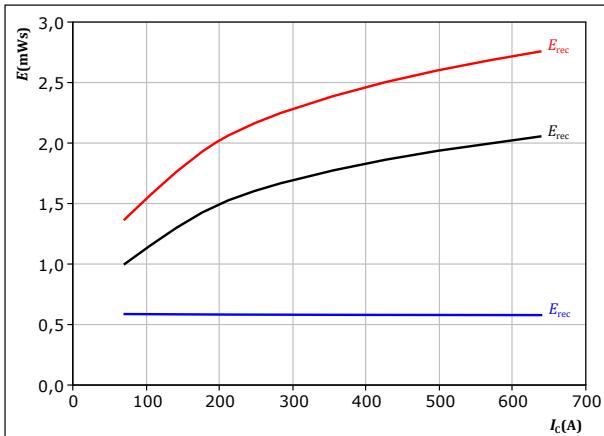
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & & \\ & & & \end{aligned}$$

figure 26.

Typical reverse recovered energy loss as a function of collector current

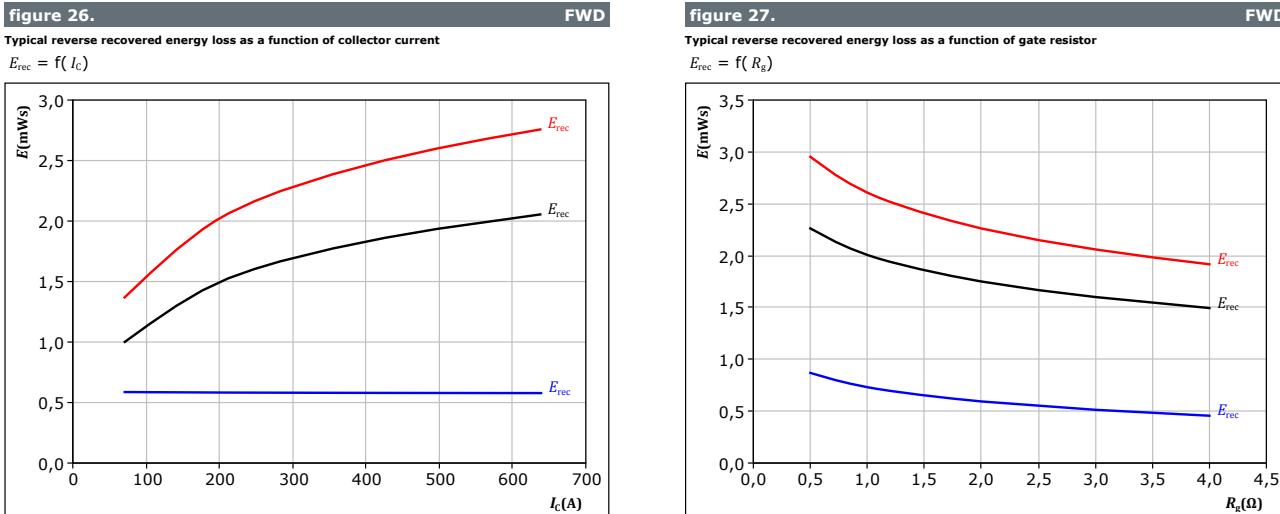
FWD

$$E_{rec} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \end{aligned}$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & & \end{aligned}$$



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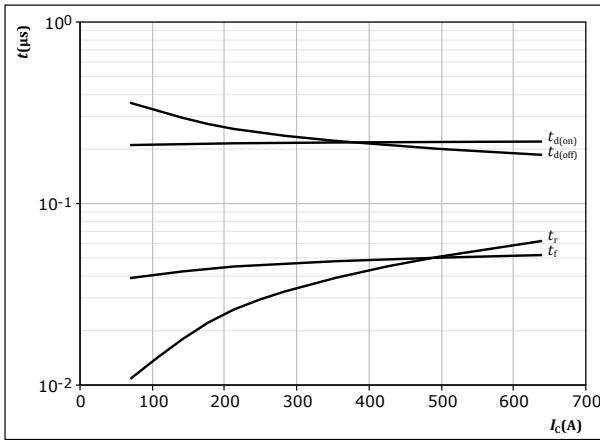
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B0-SL10NIC600S701-PA39F48Z

datasheet

Buck Switching Characteristics

figure 28.

Typical switching times as a function of collector current
 $t = f(I_C)$



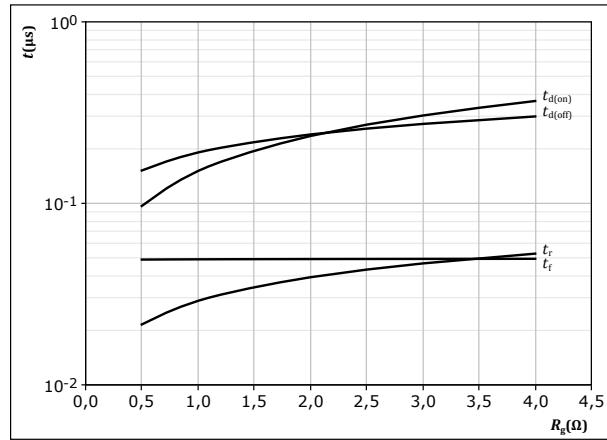
With an inductive load at

T _j =	150	°C
V _{CE} =	600	V
V _{GE} =	±15	V
R _{gon} =	2	Ω
R _{goff} =	2	Ω

IGBT

figure 29.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



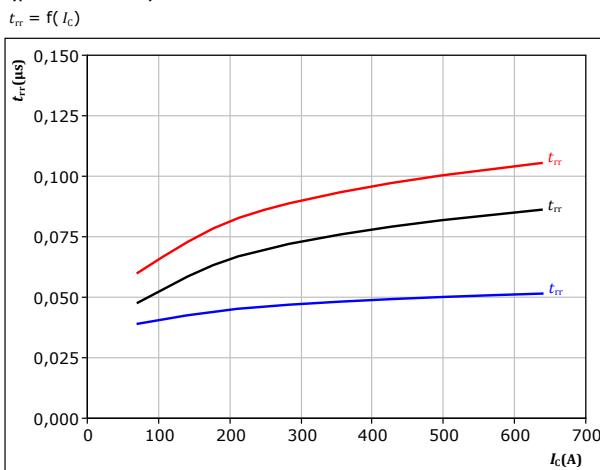
With an inductive load at

T _j =	150	°C
V _{CE} =	600	V
V _{GE} =	±15	V
I _C =	355	A

IGBT

figure 30.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

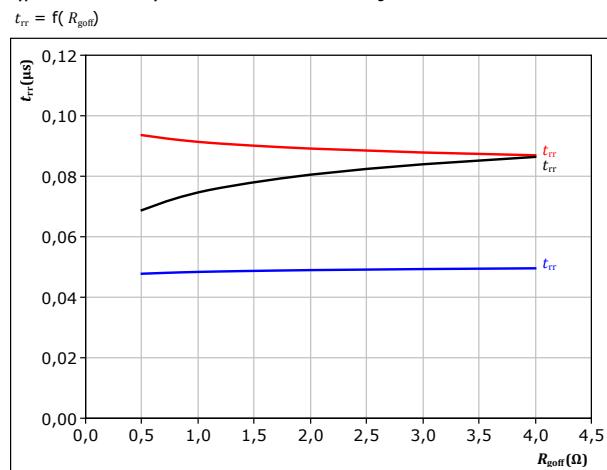
V _{CE} =	600	V
V _{GE} =	±15	V
R _{gon} =	2	Ω

$T_j:$ — 25 °C — 125 °C — 150 °C

FWD

figure 31.

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

V _{CE} =	600	V
V _{GE} =	±15	V
I _C =	355	A

$T_j:$ — 25 °C — 125 °C — 150 °C



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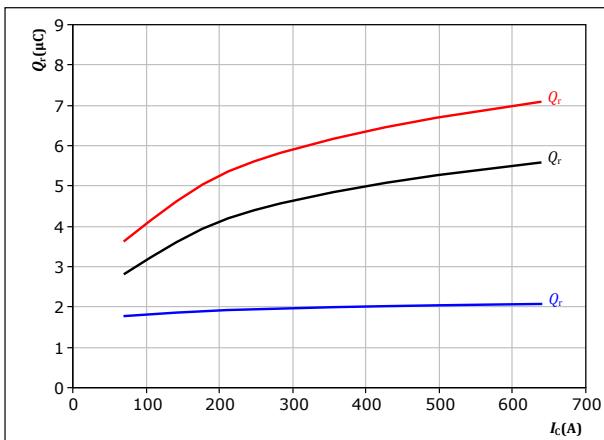
datasheet

Buck Switching Characteristics

figure 32.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

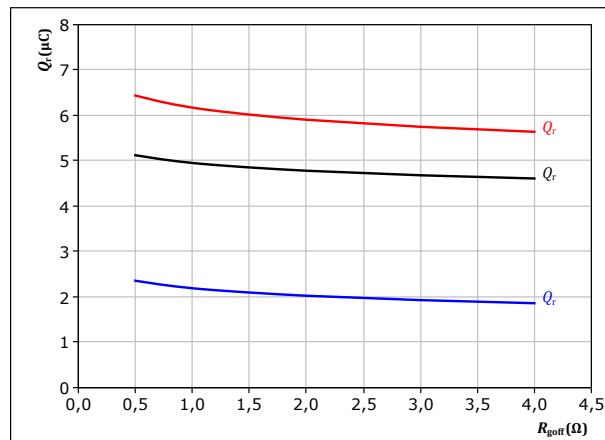
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \end{aligned}$$

FWD

figure 33.

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{go\bar{n}})$$



With an inductive load at

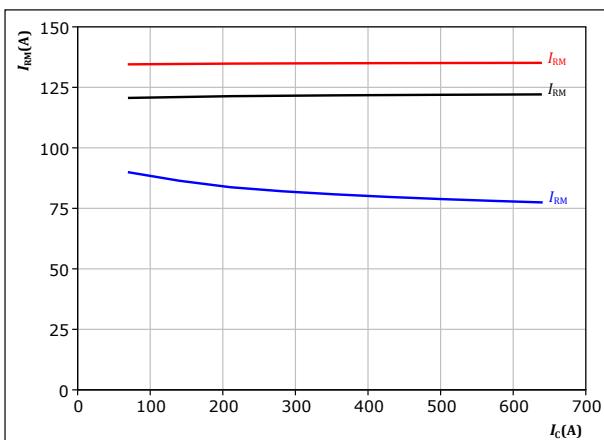
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & & \end{aligned}$$

FWD

figure 34.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

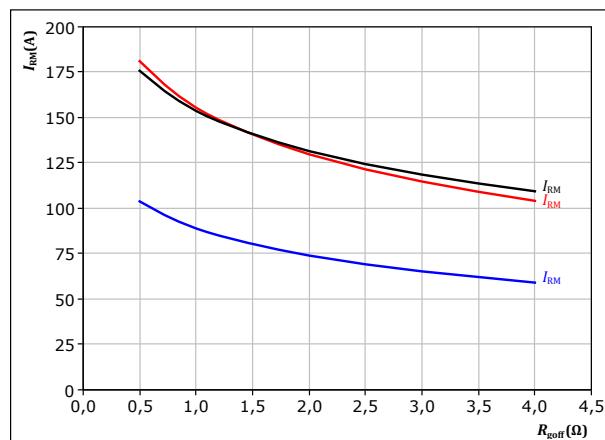
$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 2 \Omega & & \end{aligned}$$

FWD

figure 35.

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{go\bar{n}})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 355 \text{ A} & & \end{aligned}$$

FWD



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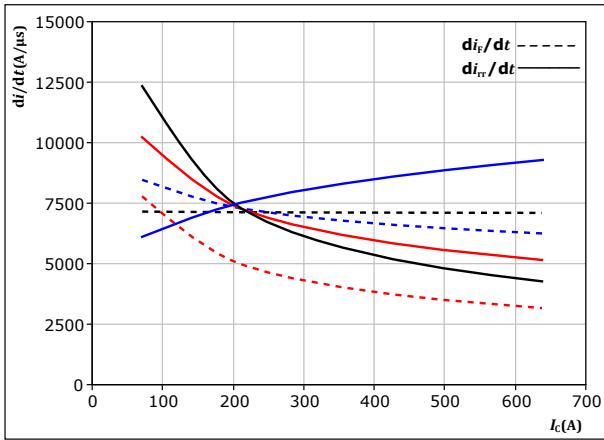
datasheet

Buck Switching Characteristics

figure 36.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



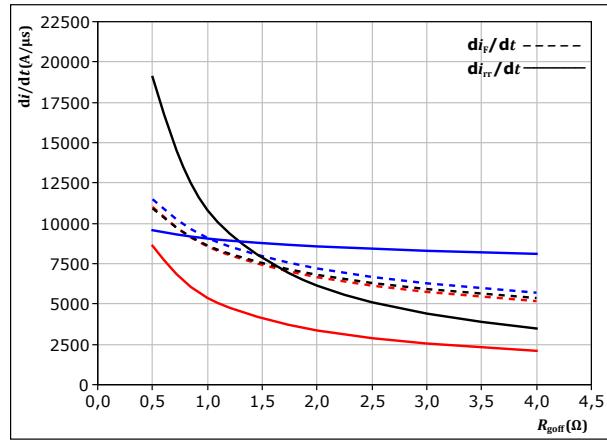
With an inductive load at

$V_{CE} = 600$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V 125°C
 $R_{gon} = 2$ Ω 150°C

figure 37.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



With an inductive load at

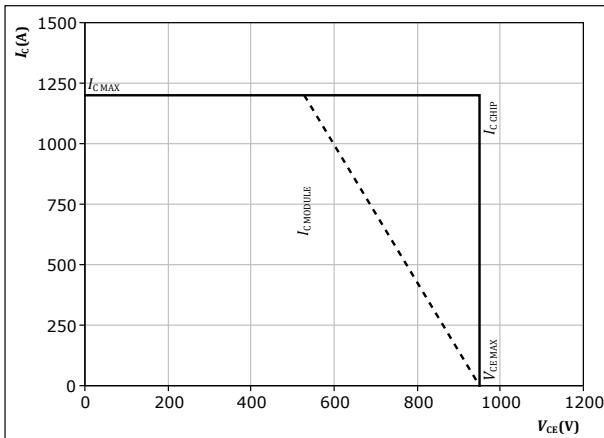
$V_{CE} = 600$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V 125°C
 $I_c = 355$ A 150°C

figure 38.

IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150^\circ\text{C}$

$R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω



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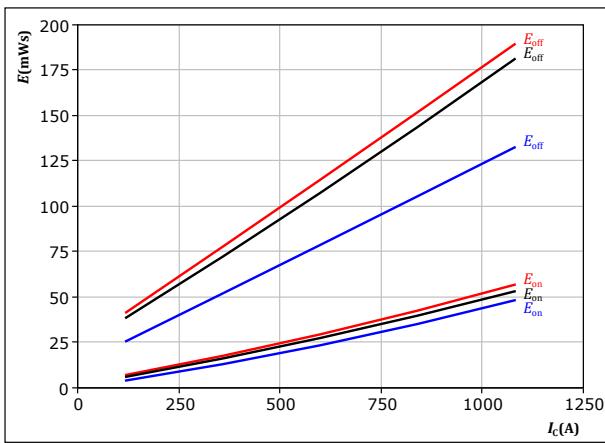
datasheet

Boost Switching Characteristics

figure 39.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 2 \Omega$$

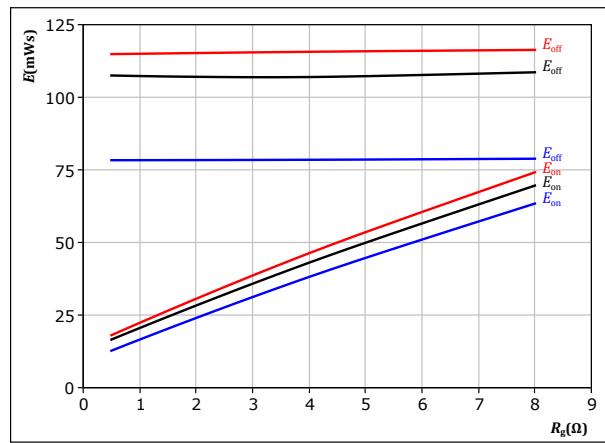
$$R_{goff} = 2 \Omega$$

IGBT

figure 40.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

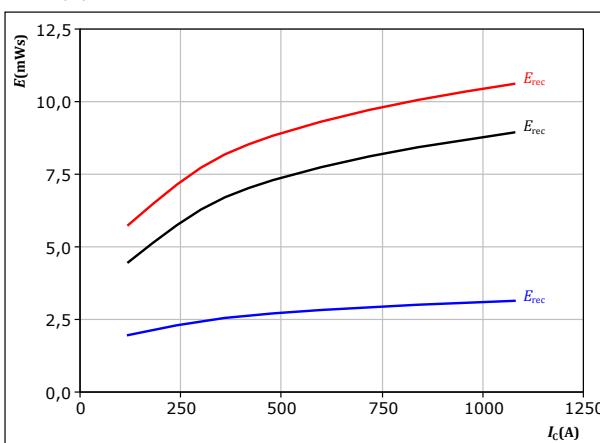
$$I_c = 600 \text{ A}$$

IGBT

figure 41.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

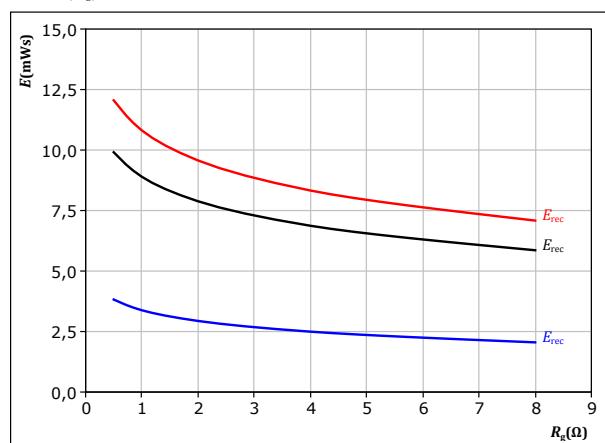
$$R_{gon} = 2 \Omega$$

FWD

figure 42.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$I_c = 600 \text{ A}$$

FWD



Vincotech

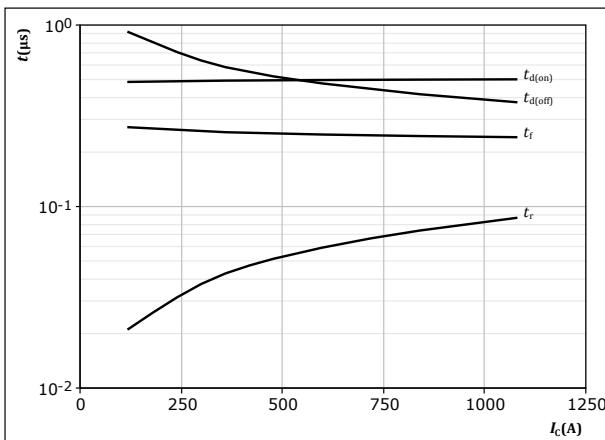
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B0-SL10NIC600S701-PA39F48Z

datasheet

Boost Switching Characteristics

figure 43.

Typical switching times as a function of collector current
 $t = f(I_C)$



With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$

IGBT

figure 44.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



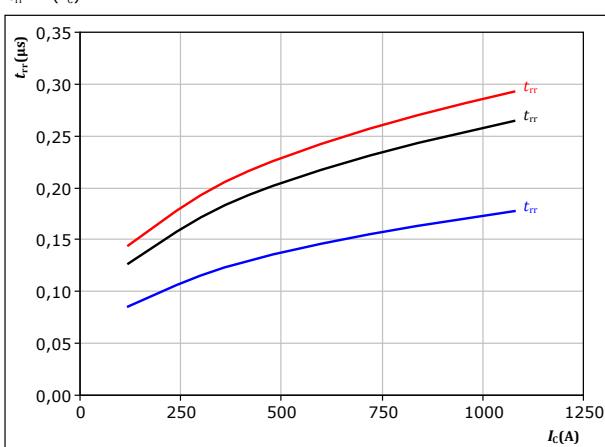
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 600 \text{ A}$

IGBT

figure 45.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



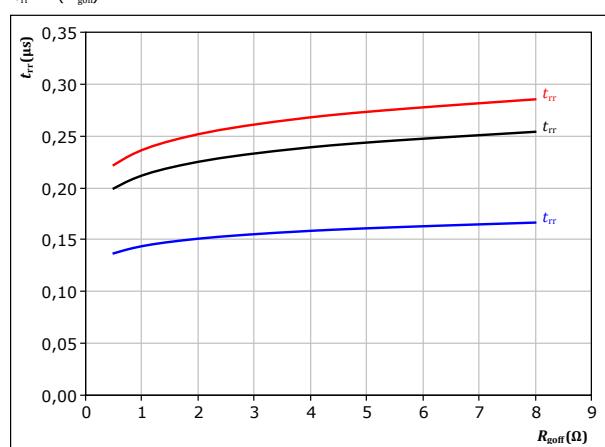
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

FWD

figure 46.

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 600 \text{ A}$

FWD



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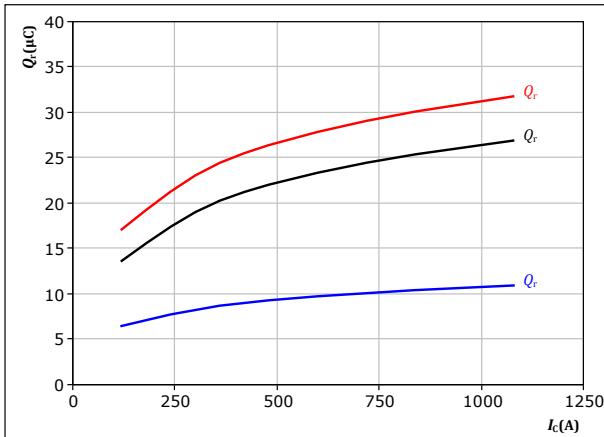
datasheet

Boost Switching Characteristics

figure 47.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

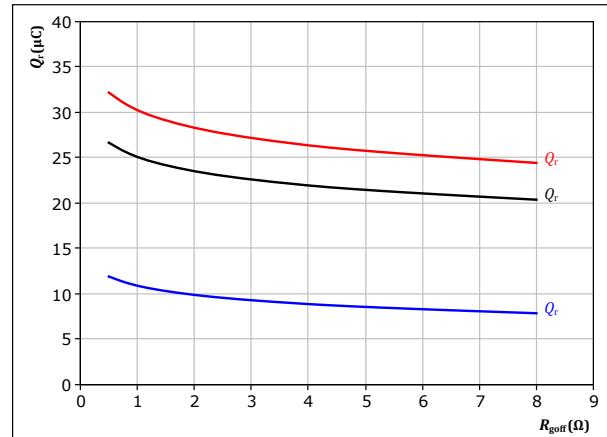
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

FWD

figure 48.

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{go\bar{n}})$$



With an inductive load at

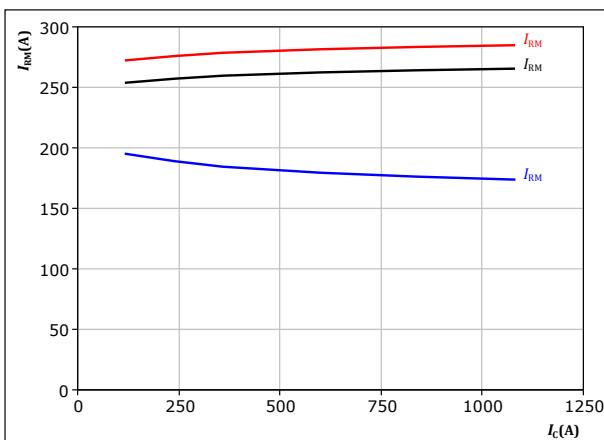
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 600 \text{ A} \end{aligned}$$

FWD

figure 49.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

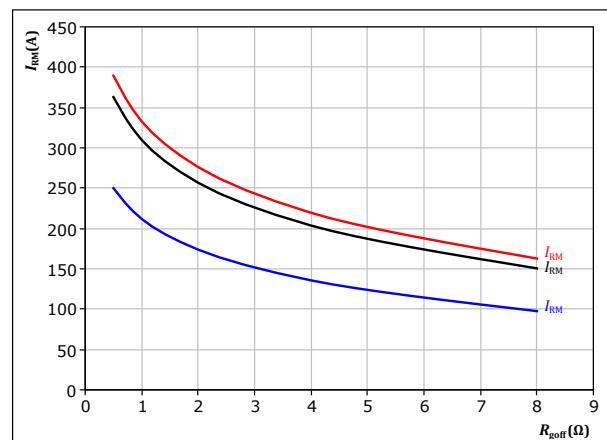
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

FWD

figure 50.

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{go\bar{n}})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 600 \text{ A} \end{aligned}$$

FWD



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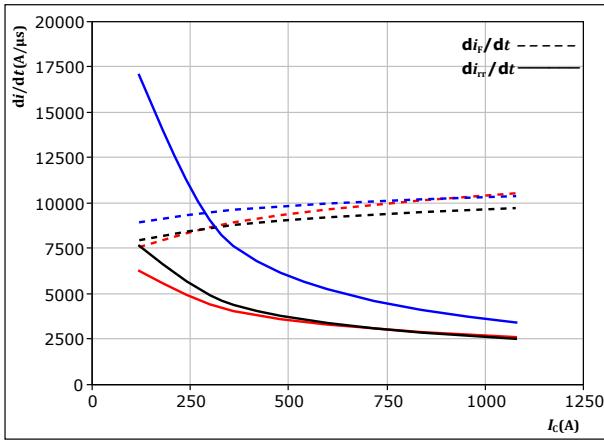
datasheet

Boost Switching Characteristics

figure 51. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

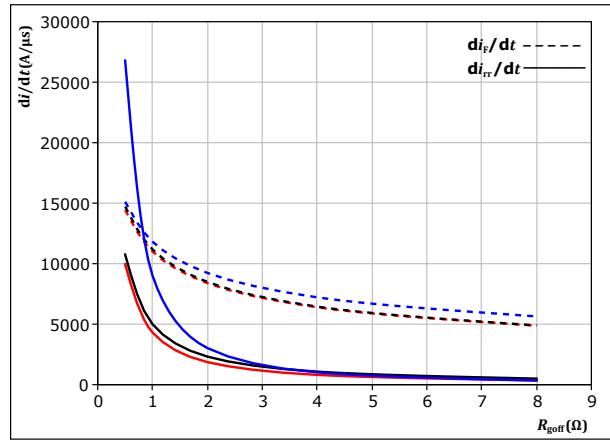
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 52. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor

$di_f/dt, di_{rr}/dt = f(R_{goff})$



With an inductive load at

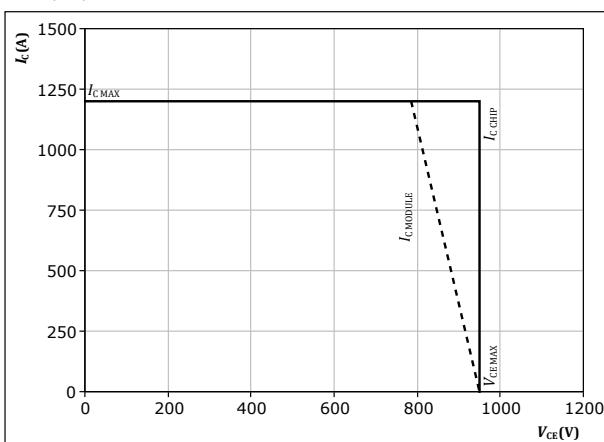
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 600 \text{ A}$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 53. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150 \text{ °C}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$



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**B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z**

datasheet

Switching Definitions

figure 54. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

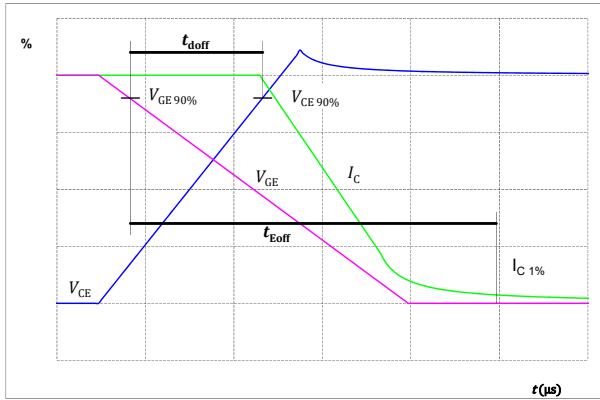


figure 56. IGBT

Turn-off Switching Waveforms & definition of t_f

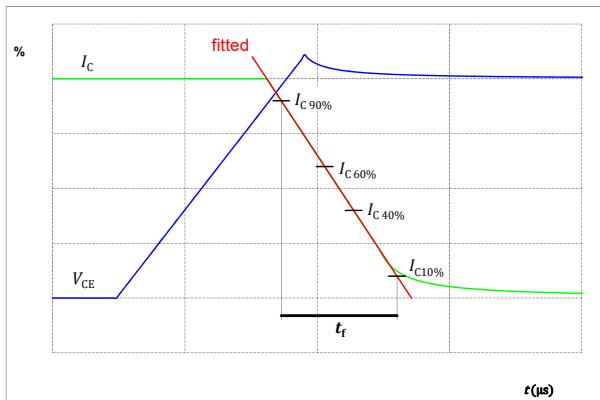


figure 55. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

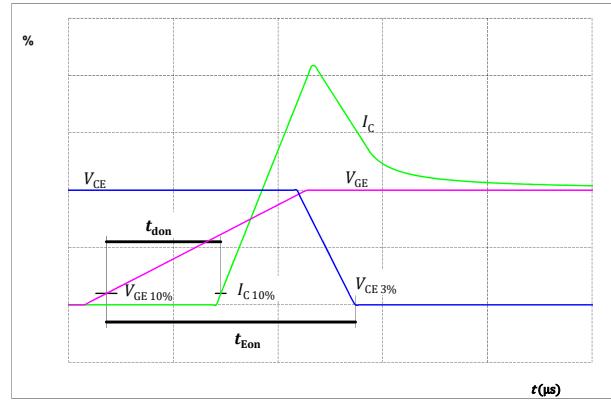
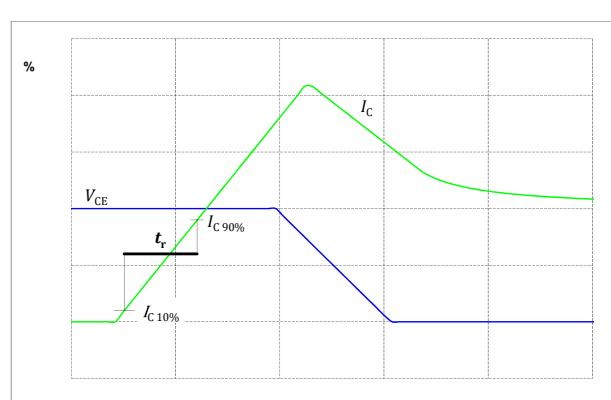


figure 57. IGBT

Turn-on Switching Waveforms & definition of t_r





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B0-SL10NIB600S701-PA29F48Z
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Switching Definitions

figure 58.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

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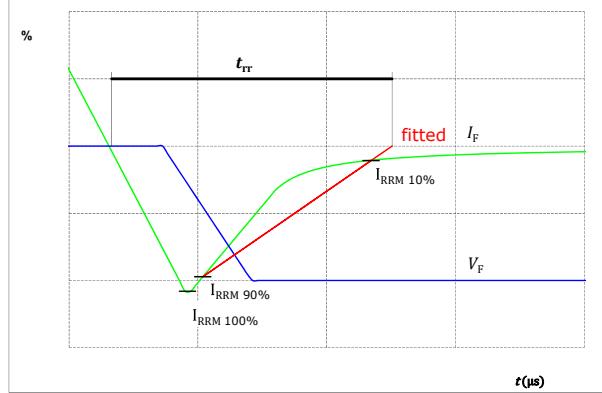
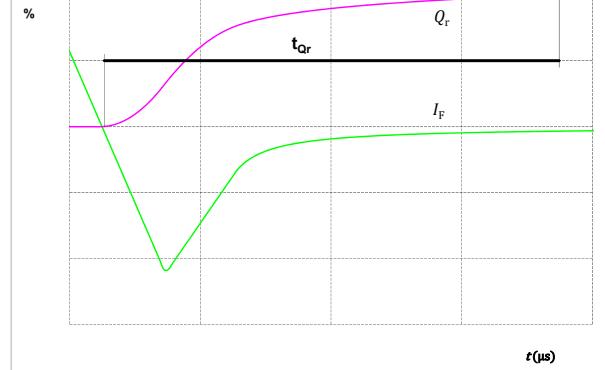


figure 59.

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)

FWD

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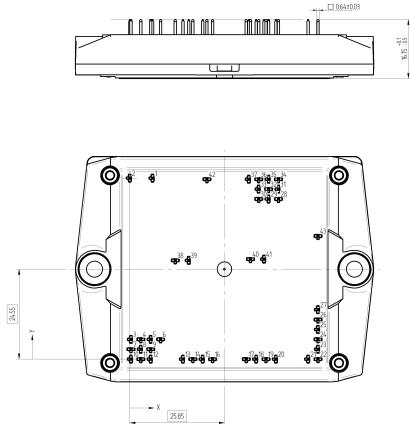
datasheet

Ordering Code	
Version	Ordering Code
With thermal paste (4,4 W/mK, PTM6000)	BO-SL10NIB600S701-PA29F48Z-/7/

Marking						
NN-NNNNNNNNNNNN TTTTTTVVWWYY UL VIN LLLLLL SSSS	Text	Name	Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTTVV	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY		

High Side Module BO-SL10NIB600S701-PA29F48Z

Pin table [mm]				Outline
Pin	X	Y	Function	
1	6,2	49,4	Therm1	
2	0	49,4	Therm2	
3	0,3	5,4	DC+	
4	3	5,4	DC+	
5	5,7	5,4	DC+	
6	8,4	5,4	DC+	
7	0,3	2,7	DC+	
8	3	2,7	DC+	
9	5,7	2,7	DC+	
10	0,3	0	DC+	
11	3	0	DC+	
12	5,7	0	DC+	
13	14,5	0	GND	
14	17,2	0	GND	
15	19,9	0	GND	
16	22,6	0	GND	
17	31,8	0	GND	
18	34,5	0	GND	
19	37,2	0	GND	
20	39,9	0	GND	
21	48,7	0	DC-	
22	51,4	0	DC-	
23	51,4	2,7	DC-	
24	51,4	5,4	DC-	
25	51,4	8,1	DC-	
26	51,4	10,8	DC-	
27	51,4	13,5	DC-	
28	40,6	43,7	Ph	
29	37,9	43,7	Ph	
30	35,2	43,7	Ph	
31	40,6	46,4	Ph	
32	37,9	46,4	Ph	
33	35,2	46,4	Ph	
34	40,6	49,1	Ph	
35	37,9	49,1	Ph	
36	35,2	49,1	Ph	
37	32,5	49,1	Ph	
38	12,4	26,95	G11	
39	16,1	26,95	S11	
40	32,95	27,3	G13	
41	36,65	27,3	S13	
42	21,05	49,1	P	
43	51,4	33,6	N	





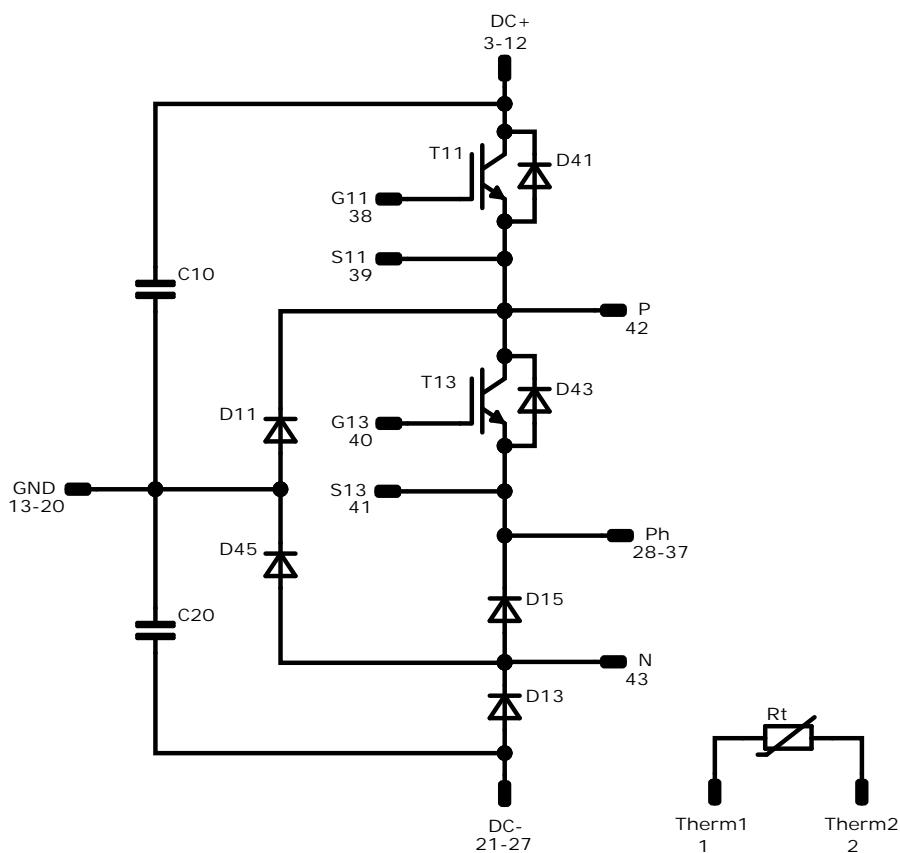
B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z

Vincotech

datasheet

High Side Module B0-SL10NIB600S701-PA29F48Z

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11	IGBT	950 V	600 A	Buck Switch	
D11	FWD	1200 V	160 A	Buck Diode	
D41	FWD	950 V	100 A	Buck Sw. Protection Diode	
T13	IGBT	950 V	600 A	Boost Switch	
D13	FWD	950 V	300 A	Boost Diode	
D15	FWD	950 V	300 A	Boost Sw. Inv. Diode	
D43	FWD	950 V	100 A	Boost Sw. Protection Diode	
D45	FWD	950 V	100 A	Boost D. Protection Diode	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	



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B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z

datasheet

Ordering Code	
Version	Ordering Code
With thermal paste (4,4 W/mK, PTM6000)	B0-SL10NIC600S701-PA39F48Z-/7/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNN	WWYY	UL VIN	LLLLL	SSSS	
Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY		

Low Side Module B0-SL10NIC600S701-PA39F48Z

Pin table [mm]				Outline
Pin	X	Y	Function	
1	51,45	49,45	Therm1	
2	46	49,45	Therm2	
3	21,8	49,1	Ph	
4	19,1	49,1	Ph	
5	16,4	49,1	Ph	
6	13,7	49,1	Ph	
7	11	49,1	Ph	
8	21,8	46,4	Ph	
9	19,1	46,4	Ph	
10	16,4	46,4	Ph	
11	13,7	46,4	Ph	
12	11	46,4	Ph	
13	0	25	DC+	
14	0	22,3	DC+	
15	0	19,6	DC+	
16	0	16,9	DC+	
17	0	14,2	DC+	
18	0	11,5	DC+	
19	0	8,8	DC+	
20	0	0	GND	
21	2,6	0	GND	
22	5,2	0	GND	
23	7,8	0	GND	
24	39	0	GND	
25	41,6	0	GND	
26	44,2	0	GND	
27	46,8	0	GND	
28	51,1	6,45	DC-	
29	48,4	9,15	DC-	
30	51,1	9,15	DC-	
31	51,1	11,85	DC-	
32	51,1	14,55	DC-	
33	51,1	17,25	DC-	
34	48,4	19,95	DC-	
35	51,1	19,95	DC-	
36	51,1	22,65	DC-	
37	51,1	25,35	DC-	
38	28,6	26,95	G14	
39	32,3	26,95	S14	
40	46,05	29,35	G12	
41	49,75	29,35	S12	
42	7,35	33,6	P	
43	32,3	49,1	N	



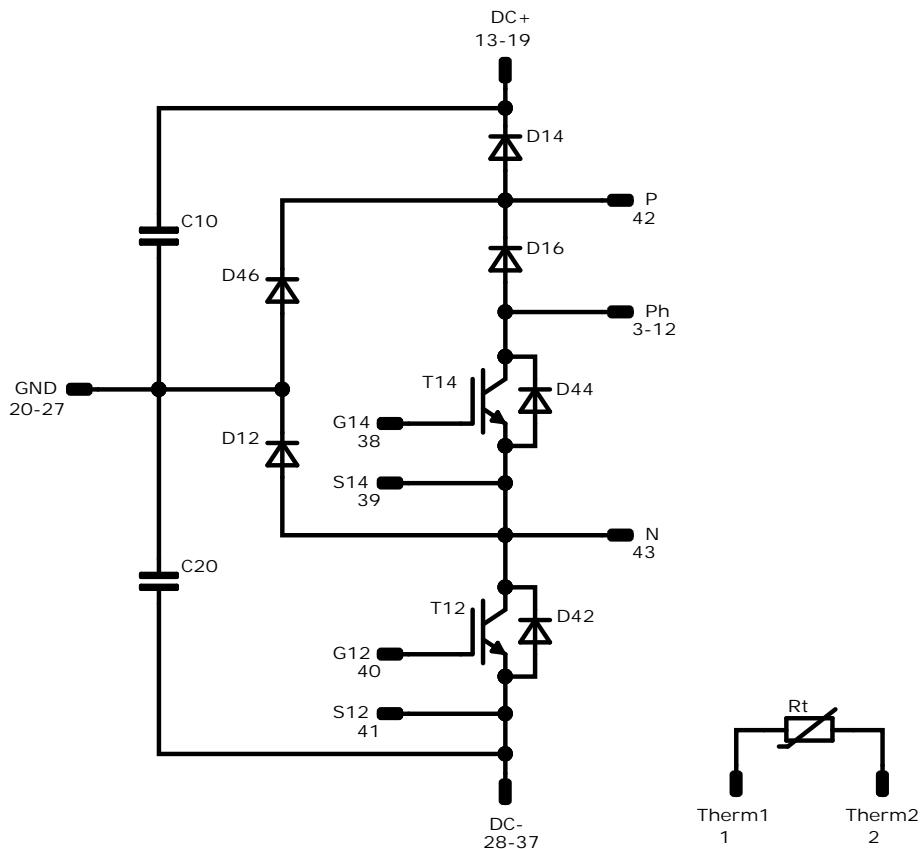
B0-SL10NIB600S701-PA29F48Z
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datasheet

Low Side Module B0-SL10NIC600S701-PA39F48Z

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T12	IGBT	950 V	600 A	Buck Switch	
D12	FWD	1200 V	160 A	Buck Diode	
D42	FWD	950 V	100 A	Buck Sw. Protection Diode	
T14	IGBT	950 V	600 A	Boost Switch	
D14	FWD	950 V	300 A	Boost Diode	
D16	FWD	950 V	300 A	Boost Sw. Inv. Diode	
D44	FWD	950 V	100 A	Boost Sw. Protection Diode	
D46	FWD	950 V	100 A	Boost D. Protection Diode	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	



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**B0-SL10NIB600S701-PA29F48Z
B0-SL10NIC600S701-PA39F48Z**

datasheet

Packaging instruction

Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow S3 packages see vincotech.com website.

Package data

Package data for flow S3 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
B0-SL10NIx600S701-PAx9F48Z-D1-14	23 Jul. 2021		

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